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# N-Channel PowerTrench<sup>®</sup> MOSFET 30 V, 5.5 m $\Omega$

### Features

- Max  $r_{DS(on)}$  = 5.5 m $\Omega$  at V<sub>GS</sub> = 10 V, I<sub>D</sub> = 19 A
- Max  $r_{DS(on)}$  = 7.6 m $\Omega$  at V<sub>GS</sub> = 4.5 V, I<sub>D</sub> = 15 A
- Advanced Package and Silicon design for low r<sub>DS(on)</sub> and high efficiency
- Next generation enhanced body diode technology, engineered for soft recovery. Provides Schottky-like performance with minimum EMI in sync buck converter applications
- MSL1 robust package design
- 100% UIL tested
- RoHS Compliant

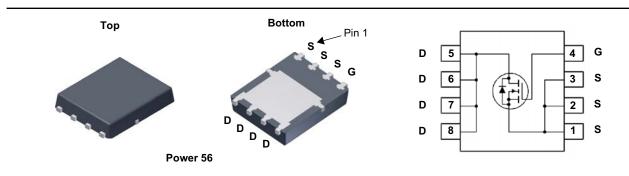


## **General Description**

This N-Channel MOSFET has been designed specifically to improve the overall efficiency and to minimize switch node ringing of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low r<sub>DS(on)</sub>, fast switching speed and body diode reverse recovery performance.

### Applications

- IMVP Vcore Switching for Notebook
- VRM Vcore Switching for Desktop and Server
- OringFET / Load Switch
- DC-DC Conversion



## MOSFET Maximum Ratings T<sub>A</sub> = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V <sub>DS</sub>	Drain to Source Voltage			30	V	
V <sub>GS</sub>	Gate to Source Voltage		(Note 4)	±20	V	
ID	Drain Current -Continuous (Package limited)	T <sub>C</sub> = 25 °C		28	A	
	-Continuous (Silicon limited)	T <sub>C</sub> = 25 °C		76		
	-Continuous	T <sub>A</sub> = 25 °C	(Note 1a)	16		
	-Pulsed			90		
E <sub>AS</sub>	Single Pulse Avalanche Energy		(Note 3)	72	mJ	
P <sub>D</sub>	Power Dissipation	T <sub>C</sub> = 25 °C 48		48	W	
	Power Dissipation	T <sub>A</sub> = 25 °C	(Note 1a)	2.5	VV	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range			-55 to +150	°C	

#### **Thermal Characteristics**

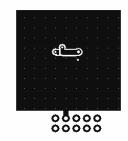
$R_{\theta JC}$	Thermal Resistance, Junction to Case		2.6	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	50	0/00

#### **Package Marking and Ordering Information**

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS7676	FDMS7676	Power 56	13 "	12 mm	3000 units

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	cteristics					
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	I <sub>D</sub> = 250 μA, V <sub>GS</sub> = 0 V	30			V
$\Delta BV_{DSS}$ $\Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$ , referenced to 25 °C		15		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 24 V, V <sub>GS</sub> = 0 V			1	μA
I <sub>GSS</sub>	Gate to Source Leakage Current, Forward	$V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$			100	nA
	cteristics	J		-		1
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = 250 μA	1.25	2.0	3.0	V
$\Delta V_{GS(th)}$	Gate to Source Threshold Voltage		0		0.0	-
$\Delta T_J$	Temperature Coefficient	$I_D$ = 250 $\mu$ A, referenced to 25 °C		-7		mV/°C
r <sub>DS(on)</sub>		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 19 A		3.8	5.5	
	Static Drain to Source On Resistance	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 15 A		5.4	7.6	mΩ
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 19 A, T <sub>J</sub> = 125 °C	25 °C 5.2 7.			
9 <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> = 5 V, I <sub>D</sub> = 19 A		64		S
Dynamic	Characteristics					
C <sub>iss</sub>	Input Capacitance			2225	2960	pF
C <sub>oss</sub>	Output Capacitance	$V_{DS} = 15 V, V_{GS} = 0 V,$		685	910	pF
C <sub>rss</sub>	Reverse Transfer Capacitance	f = 1 MHz		90	130	pF
R <sub>g</sub>	Gate Resistance			0.7	1.5	Ω
•	Characteristics					1
	Turn-On Delay Time			13	23	ns
t <sub>d(on)</sub> t <sub>r</sub>	Rise Time	V <sub>DD</sub> = 15 V, I <sub>D</sub> = 19 A,		5	10	ns
	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		25	40	ns
t <sub>d(off)</sub> t <sub>f</sub>	Fall Time			4	10	ns
ч Q <sub>g</sub>	Total Gate Charge	V <sub>GS</sub> = 0 V to 10 V		31	44	nC
Q <sub>g</sub>	Total Gate Charge	$V_{GS} = 0 V \text{ to } 4.5 V$ $V_{DD} = 15 V$ ,		14	19	nC
Q <sub>gs</sub>	Gate to Source Charge	$I_{\rm D} = 19  {\rm A}$		7.6	10	nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge			3.7		nC
-				0.7		110
50l	urce Diode Characteristics	V <sub>GS</sub> = 0 V, I <sub>S</sub> = 2.1 A (Note 2)		0.7	0.95	
V <sub>SD</sub>	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 2.1 A$ (Note 2) $V_{GS} = 0 V, I_S = 19 A$ (Note 2)		0.7	1.1	- V
t <sub>rr</sub>	Reverse Recovery Time			32	51	ns
Q <sub>rr</sub>	Reverse Recovery Charge	4 +		14	24	nC
t <sub>a</sub>	Reverse Recovery Fall Time	Ι <sub>F</sub> = 19 A, di/dt = 100 A/μs		15		nC
t <sub>b</sub>	Reverse Recovery Rise Time			17		nC
-11	-	4 -				
	Softness (f, /f )	1				
S t <sub>rr</sub>	Softness (t <sub>b</sub> /t <sub>a</sub> ) Reverse Recovery Time	- I <sub>F</sub> = 19 A, di/dt = 300 A/μs		1.1 26	42	ns

Notes: 1. R<sub>0JA</sub> is determined with the device mounted on a 1in<sup>2</sup> pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R<sub>0JC</sub> is guaranteed by design while R<sub>0CA</sub> is determined by the user's board design.



a. 50 °C/W when mounted on a 1 in<sup>2</sup> pad of 2 oz copper.

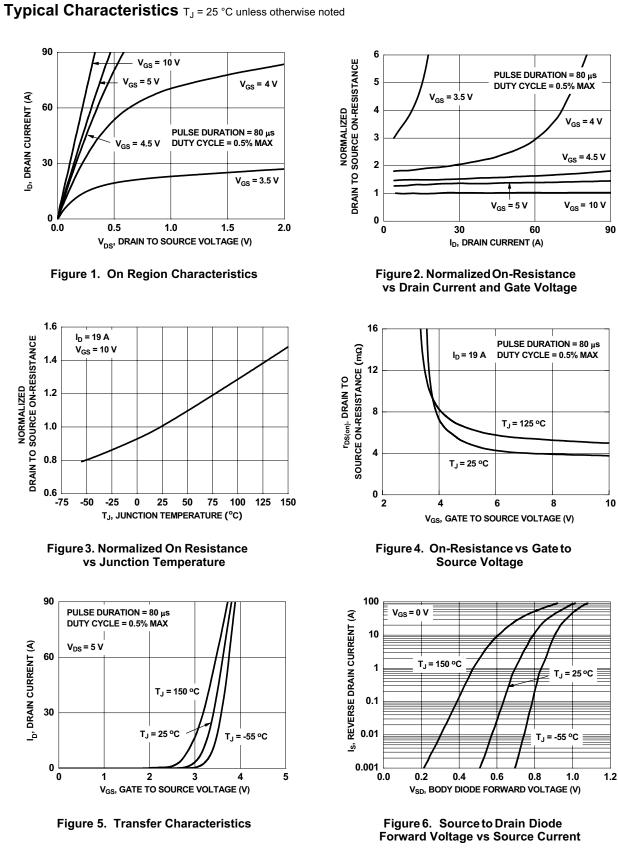


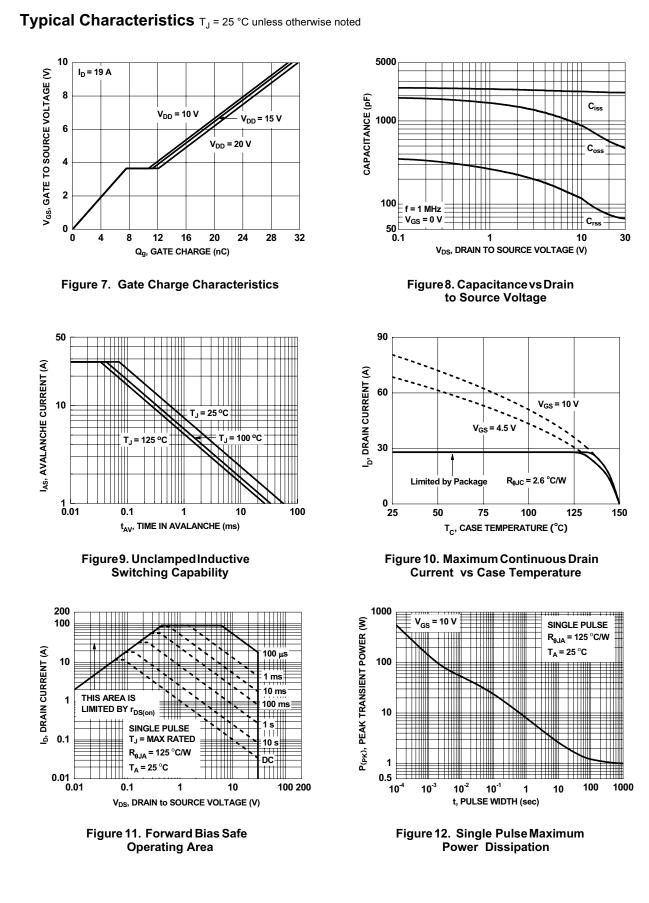
b. 125 °C/W when mounted on a minimum pad of 2 oz copper.

2. Pulse Test: Pulse Width < 300  $\mu$ s, Duty cycle < 2.0%. 3. E<sub>AS</sub> of 72 mJ is based on starting T<sub>J</sub> = 25 °C, L = 1 mH, I<sub>AS</sub> = 12 A, V<sub>DD</sub> = 27 V, V<sub>GS</sub> = 10 V. 100% test at L = 0.3 mH, I<sub>AS</sub> = 17 A.

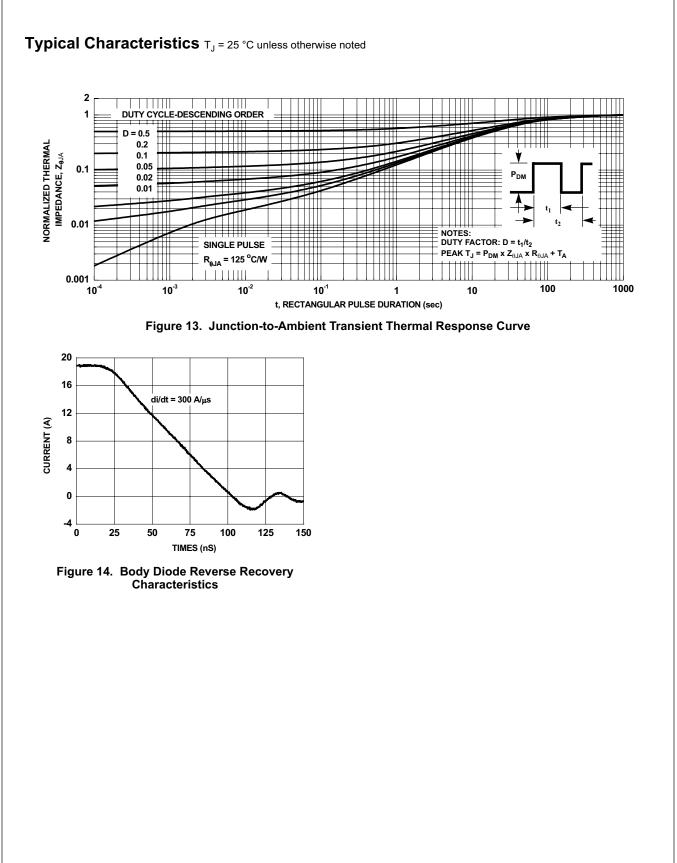
4. As an N-ch device, the negative Vgs rating is for low duty cycle pulse occurrence only. No continuous rating is implied.

FDMS7676 N-Channel PowerTrench<sup>®</sup> MOSFET





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